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CONFIRMATION NO. 5712

<b>SERIAL NUMBER</b> 10/808,502	<b>FILING OR 371(c) DATE</b> 03/25/2004 <b>RULE</b>	<b>CLASS</b> 174	<b>GROUP ART UNIT</b> 2841	<b>ATTORNEY DOCKET NO.</b> 1186.1033
<b>APPLICANTS</b> <i>ten</i> Takehito Tsukamoto, Tokyo, JAPAN; Hiroshi Matsuzawa, Tokyo, JAPAN; Satoshi Akimoto, Tokyo, JAPAN; Masataka Maehara, Tokyo, JAPAN; Takumi Suemoto, Tokyo, JAPAN; Masayuki Ode, Tokyo, JAPAN; Yuichi Sakaki, Tokyo, JAPAN;				
<b>** CONTINUING DATA</b> ***** <i>ten</i> ***** This application is a CON of PCT/JP02/10172 09/30/2002				
<b>** FOREIGN APPLICATIONS</b> ***** <i>ten</i> ***** JAPAN 2001-304651 09/28/2001				
<b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 06/07/2004</b>				
Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance		<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 16	<b>TOTAL CLAIMS</b> 51
Verified and Acknowledged Examiner's Signature <i>ten</i> Initials <i>ten</i>	<b>INDEPENDENT CLAIMS</b> 12			
<b>ADDRESS</b> 21171				
<b>TITLE</b> Multi-layer wiring board, IC package, and method of manufacturing multi-layer wiring board				
<b>FILING FEE RECEIVED</b> 2102	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit	